Electronic Acknowledgement Receipt				
EFS ID:	8248406			
Application Number:	10587725			
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Confirmation Number:	2259			
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First Named Inventor/Applicant Name:	Etsuro Morita			
Customer Number:	23581			
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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /₊zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	20100818_Third_Supplemental _IDS_SB08a-EFS_as- filed_SHX373.pdf	612512	no	4
			07e25299a38295b3dd4491607f122621f75 4f2b8		

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2	Foreign Reference	JP0411551_Suzuki_w-English-	888638	no	5	
2		abs.pdf	c09dc4fee70b467963281550ae23c259368 9db8a			
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3	Foreign Reference	JP04206766_Shigeniwa_w-	1326539	no	7	
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6	NPL Documents	GASSEL_etal_SIMOX_and_Waf	1889710	no	2	
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7	NPL Documents	TONG_etal_VLSI_SOI_Fabrication_by_SIMOX_Wafer_Bonding.	718360	no	2	
		pdf	fbbc3980d2d6f54804a4fbaf90145461deb7 22af			
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8	NPL Documents	YANG_etal_Silicon-on- Insulator-with-Active-	730908	no	2	
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